FEATURES

- * High Speed Switching
- * Low Saturation Voltage
 - : V_{CE}(sat) = 1.95 V (@ Ic=6.5A)
- * High Input Impedance
- *CO-PAK, IGBT with FRD
 - : Trr = 37nS (typ.)

APPLICATIONS

- * AC & DC Motor controls
- * General Purpose Inverters
- * Robotics , Servo Controls
- * Power Supply
- * Lamp Ballast

ABSOLUTE MAXIMUM RATINGS

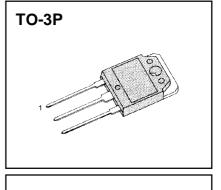
Symbol	Characteristics	Rating	Units
V _{CES}	Collector-Emitter Voltage	600	V
V _{GES}	Gate-Emitter Voltage	±20	V
I _C	Collector Current @ Tc = 25°C	13	А
	Collector Current @ Tc = 100°C	6.5	А
I _{CM (1)}	Pulsed Collector Current	52	А
I _F	Diode Continuous Forward Current @ Tc = 100°C	8	А
I _{FM}	Diode Maximum Forward Current	56	А
P _D	Maximum Power Dissipation @Tc = 25°C	60	W
	Maximum Power Dissipation @Tc = 100°C	25	W
Тј	Operating Junction Temperature	-55 ~ 150	°C
Tstg	Storage Temperature Range	-55 ~ 150	°C
TL	Maximum Lead Temp. For Soldering	300	°C
	Purposes, 1/8" from case for 5 seconds		

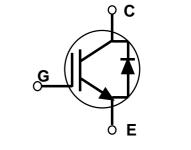
Notes:(1) Repetitive rating : Pulse width limited by max. junction temperature











ELECTRICAL CHARACTERISTICS (IGBT PART)

(Tc=25°C,Unless Otherwise Specified)

Symbol	Characteristics	Test Conditions	Min	Тур	Max	Units
BV _{CES}	C - E Breakdown Voltage	$V_{GE} = 0V$, $I_C = 250uA$	600	-	-	V
$\Delta V_{CES/}$	Temperature Coeff. of	$V_{GE} = 0V$, $I_C = 1mA$	-	0.6	-	V/°C
ΔT_{J}	Breakdown Voltage					
V _{GE(th)}	G - E threshold voltage	$I_{\rm C}$ = 6.5mA , $V_{\rm CE}$ = $V_{\rm GE}$	4.0	5.5	7.5	V
I _{CES}	Collector cutoff Current	$V_{CE} = V_{CES}$, $V_{GE} = 0V$	-	-	250	uA
I _{GES}	G - E leakage Current	$V_{GE} = V_{GES}$, $V_{CE} = 0V$	-	-	100	nA
V _{CE} (sat)	Collector to Emitter	Ic=6.5A, V _{GE} = 15V	-	1.95	2.6	V
	saturation voltage	Ic=13A, V _{GE} = 15V	-	2.6	-	V
Cies	Input capacitance	$V_{GE} = 0V$, f = 1MHz	-	375	-	pF
Coes	Output capacitance	$V_{CE} = 30V$	-	63	-	pF
Cres	Reverse transfer capacitance		-	13	-	pF
td(on)	Turn on delay time	$V_{\rm CC} = 300 V$, $I_{\rm C} = 6.5 A$	-	15	-	nS
tr	Turn on rise time	V _{GE} = 15V	-	26	-	nS
td(off)	Turn off delay time	$R_{G} = 50\Omega$	-	50	80	nS
tf	Turn off fall time	Inductive Load	-	110	220	nS
Eon	Turn on Switching Loss		-	0.1	-	mJ
Eoff	Turn off Switching Loss		-	0.1	-	mJ
Ets	Total Switching Loss		-	0.2	0.3	mJ
Qg	Total Gate Charge	Vcc = 300V	-	25	37	nC
Qge	Gate-Emitter Charge	V _{GE} = 15V	-	7	11	nC
Qgc	Gate-Collector Charge	lc = 6.5A	-	8	12	nC
Le	Internal Emitter Inductance	Measured 5mm from PKG	-	14	-	nH



V

А

ELECTRICAL CHARACTERISTICS (DIODE PART) (Tc=25°C,Unless Otherwise Specified)

Symbol **Test Conditions** Min Тур Max Units **Characteristics** Tc =25°C VFM IF=8.0A 1.4 1.7 **Diode Forward Voltage** -Tc =100°C 1.3 --Tc =25°C Trr **Diode Reverse** nS -37 55 Tc =100°C **Recovery Time** -55 -Tc =25°C **Diode Peak Reverse** IF=8.0A, VR=200V Irr -3.5 5.0 Tc =100°C **Recovery Current** -di/dt=200A/uS 4.5 --Tc =25°C Qrr **Diode Reverse** -65 138 nC Tc =100°C **Recovery Charge** _ 124

THERMAL RESISTANCE

Symbol	Characteristics	Min	Тур	Max	Units
R ₀ JC	Junction-to-Case (IGBT)	-	-	2.0	°C/W
R _e JC	Junction-to-Case (DIODE)	-	-	3.5	°C/W
R _e JA	Junction-to-Ambient	-	-	40	°C/W
R _e CS	Case-to-Sink	-	0.24	-	°C/W



N-CHANNEL IGBT

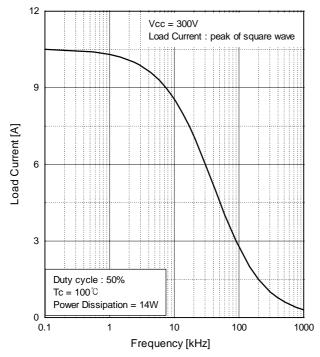


Fig.1 Typical Load Current vs. Frequency

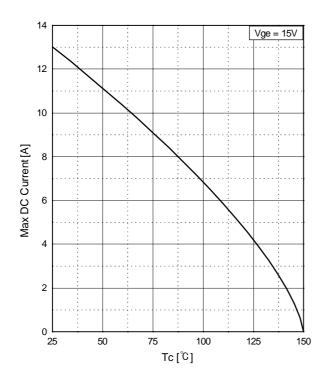


Fig.3 Maximum Collector Current vs. Case Temperature

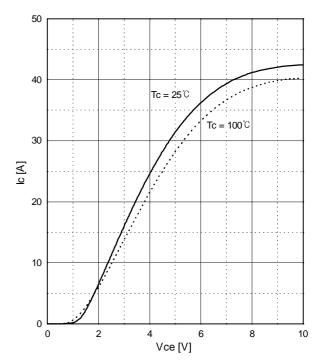


Fig.2 Typical Output Characteristics

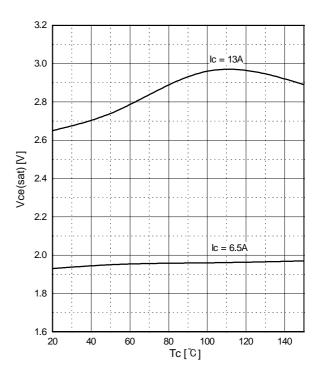


Fig.4 Collector to Emitter Voltage vs. Case Temperature



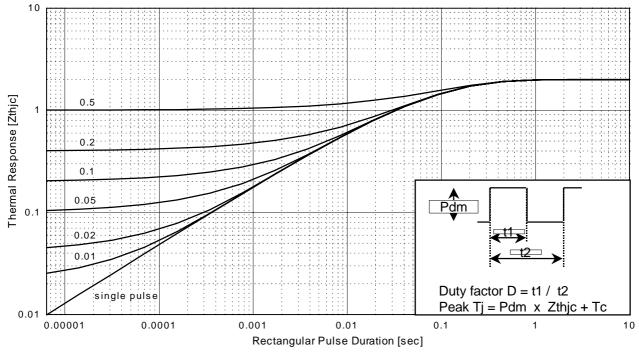
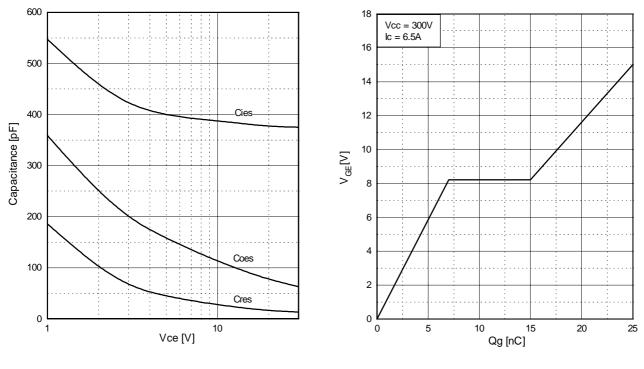
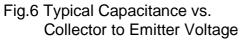


Fig.5 Maximum Effective Transient Thermal Impedance, Junction to Case









N-CHANNEL IGBT

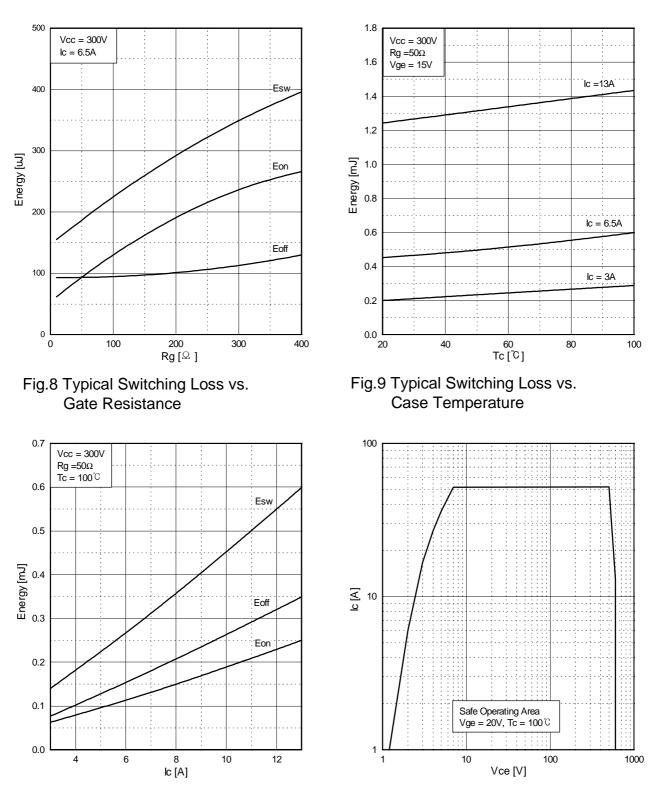


Fig.10 Typical Switching loss vs. Collector to Emitter Current

Fig.11 Turn-off SOA



N-CHANNEL IGBT

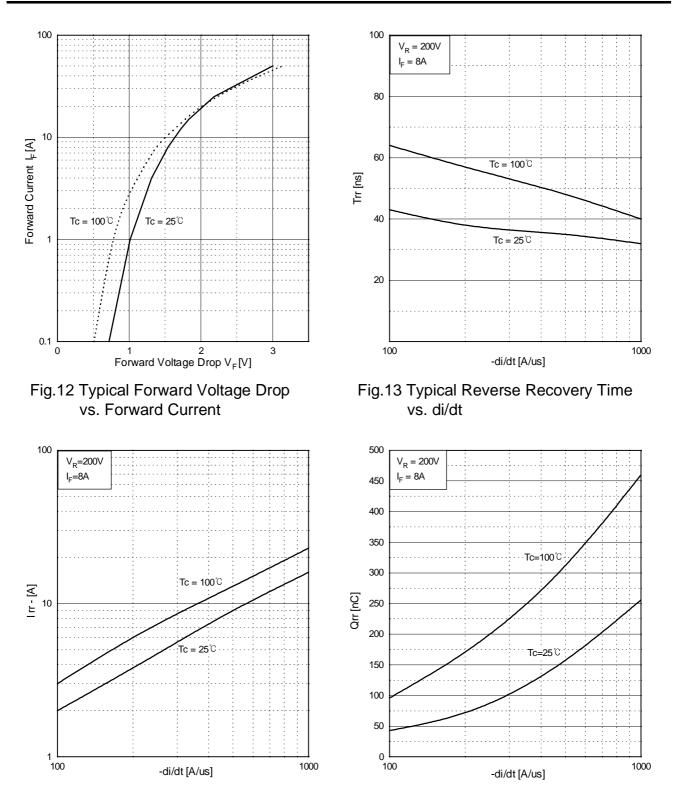


Fig.14 Typical Reverse Recovery Current vs. di/dt

Fig.15 Typical Stored Charge vs. di/dt



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FACT Quiet Series [™]	QuietSeries™
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